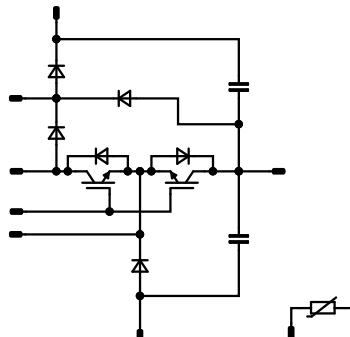




# Vincotech

<b>flowANPFC 1</b>	<b>650 V / 100 A</b>
<b>Topology features</b> <ul style="list-style-type: none"><li>• Advanced Neutral Boost PFC</li><li>• Integrated DC capacitor</li><li>• Kelvin Emitter for improved switching performance</li><li>• Temperature sensor</li></ul>	<b>flow 1 12 mm housing</b> 
<b>Component features</b> <ul style="list-style-type: none"><li>• High efficiency in hard switching and resonant topologies</li><li>• High speed switching</li><li>• Low gate charge</li></ul>	
<b>Housing features</b> <ul style="list-style-type: none"><li>• Base isolation: Al<sub>2</sub>O<sub>3</sub></li><li>• Convex shaped substrate for superior thermal contact</li><li>• Thermo-mechanical push-and-pull force relief</li><li>• Press-fit pin</li><li>• Reliable cold welding connection</li></ul>	
<b>Extra features</b> <ul style="list-style-type: none"><li>• SiC Boost Diode</li></ul>	<b>Schematic</b> 
<b>Target applications</b> <ul style="list-style-type: none"><li>• Charging Stations</li></ul>	
<b>Types</b> <ul style="list-style-type: none"><li>• 10-PY07ANA100RG01-LH23L68Y</li></ul>	



Vincotech

## Maximum Ratings

$T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>Negative Neutral Point Switch</b>				
Collector-emitter voltage	$V_{CES}$		650	V
Collector current (DC current)	$I_C$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	81	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	400	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	132	W
Gate-emitter voltage	$V_{GES}$		$\pm 30$	V
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Positive Neutral Point Switch

Collector-emitter voltage	$V_{CES}$		650	V
Collector current (DC current)	$I_C$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	81	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	400	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	132	W
Gate-emitter voltage	$V_{GES}$		$\pm 30$	V
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Negative Boost Diode

Peak repetitive reverse voltage	$V_{RRM}$		650	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	36	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	120	A
Surge (non-repetitive) forward current	$I_{FSM}$	Single Half Sine Wave, $t_p = 8,3 \text{ ms}$	120	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	64	W
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$



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## Maximum Ratings

$T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>Positive Boost Diode</b>				
Peak repetitive reverse voltage	$V_{RRM}$		650	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	36	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	120	A
Surge (non-repetitive) forward current	$I_{FSM}$	Single Half Sine Wave, $t_p = 8,3 \text{ ms}$ $T_j = 25^\circ\text{C}$	120	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	64	W
Maximum junction temperature	$T_{jmax}$		175	°C

## Negative Neutral Point Diode

Peak repetitive reverse voltage	$V_{RRM}$		1600	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	86	A
Surge (non-repetitive) forward current	$I_{FSM}$	Single Half Sine Wave, $t_p = 10 \text{ ms}$ $T_j = 150^\circ\text{C}$	890	A
Surge current capability	$I^t$		3960	$\text{A}^2\text{s}$
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	91	W
Maximum junction temperature	$T_{jmax}$		150	°C

## Positive Neutral Point Diode

Peak repetitive reverse voltage	$V_{RRM}$		1600	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	118	A
Surge (non-repetitive) forward current	$I_{FSM}$	Single Half Sine Wave, $t_p = 10 \text{ ms}$ $T_j = 150^\circ\text{C}$	1380	A
Surge current capability	$I^t$		9520	$\text{A}^2\text{s}$
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	122	W
Maximum junction temperature	$T_{jmax}$		150	°C



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## Maximum Ratings

$T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
<b>Positive Boost Diode Protection Diode</b>				
Peak repetitive reverse voltage	$V_{RRM}$		650	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	23	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	40	A
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	39	W
Maximum junction temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Positive Boost Blocking Diode

Peak repetitive reverse voltage	$V_{RRM}$		1600	V
Forward current (DC current)	$I_F$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	86	A
Surge (non-repetitive) forward current	$I_{FSM}$	Single Half Sine Wave, $t_p = 10 \text{ ms}$ $T_j = 150^\circ\text{C}$	890	A
Surge current capability	$I^t$		3960	$\text{A}^2\text{s}$
Total power dissipation	$P_{tot}$	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	91	W
Maximum junction temperature	$T_{jmax}$		150	$^\circ\text{C}$

## Capacitor (DC)

Maximum DC voltage	$V_{MAX}$		630	V
Operation Temperature	$T_{op}$		-55 ... 125	$^\circ\text{C}$

## Module Properties

### Thermal Properties

Storage temperature	$T_{stg}$		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	$T_{jop}$		-40...+( $T_{jmax} - 25$ )	$^\circ\text{C}$

### Isolation Properties

Isolation voltage	$V_{isol}$	DC Test Voltage*	$t_p = 2 \text{ s}$	6000	V
Isolation voltage	$V_{isol}$	AC Voltage	$t_p = 1 \text{ min}$	2500	V
Creepage distance				>12,7	mm
Clearance				7.55	mm
Comparative Tracking Index	CTI			$\geq 200$	

\*100 % tested in production



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## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Negative Neutral Point Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$			5	0,066	25	5	6	7	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		100	25 125 150		1,5 1,66 1,7	1,9 <sup>(1)</sup>	V
Collector-emitter cut-off current	$I_{CES}$		0	650		25			0,02	mA
Gate-emitter leakage current	$I_{GES}$		30	0		25			0,4	µA
Internal gate resistance	$r_g$							None		Ω
Input capacitance	$C_{res}$	$f = 1 \text{ MHz}$	0	30	25			8400		pF
Output capacitance	$C_{oes}$							208		pF
Reverse transfer capacitance	$C_{res}$							158		pF
Gate charge	$Q_g$		15	400	100	25		282		nC

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,72		K/W
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#### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 4 \Omega$ $R_{goff} = 4 \Omega$	0/15	400	65	25		68,47		
Rise time	$t_r$					125		59,23		ns
						150		56,87		
Turn-off delay time	$t_{d(off)}$					25		36,61		
						125		36,46		
Fall time	$t_f$					150		36,3		
Turn-on energy (per pulse)	$E_{on}$					25		198,58		
		$Q_{tFWD}=0,053 \mu\text{C}$				125		229,53		
		$Q_{tFWD}=0,052 \mu\text{C}$				150		238,96		
Turn-off energy (per pulse)	$E_{off}$	$Q_{tFWD}=0,05 \mu\text{C}$				25		28,01		
						125		44,72		
						150		48,75		
						25		0,88		mWs
						125		0,926		
						150		0,937		
						25		1,29		mWs
						125		1,72		
						150		1,85		



10-PY07ANA100RG01-LH23L68Y

datasheet

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## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Positive Neutral Point Switch

#### Static

Gate-emitter threshold voltage	$V_{GE(th)}$			5	0,066	25	5	6	7	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		100	25 125 150		1,5 1,66 1,7	1,9 <sup>(1)</sup>	V
Collector-emitter cut-off current	$I_{CES}$		0	650		25			0,02	mA
Gate-emitter leakage current	$I_{GES}$		30	0		25			0,4	µA
Internal gate resistance	$r_g$							None		Ω
Input capacitance	$C_{res}$	$f = 1 \text{ MHz}$	0	30	25	8400 208 158		8400 208 158	pF	pF
Output capacitance	$C_{oes}$									
Reverse transfer capacitance	$C_{res}$									
Gate charge	$Q_g$		15	400	100	25		282		nC

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,72		K/W
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#### Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 4 \Omega$ $R_{goff} = 4 \Omega$	0/15	400	65	25		70,62		
Rise time	$t_r$					125		60,61		ns
						150		57,85		
Turn-off delay time	$t_{d(off)}$					25		63,16		
						125		62,45		
Fall time	$t_f$					150		61,92		
Turn-on energy (per pulse)	$E_{on}$					25		200,34		
		$Q_{tFWD}=0,086 \mu\text{C}$ $Q_{rFWD}=0,082 \mu\text{C}$ $Q_{fFWD}=0,082 \mu\text{C}$	125		65	125		231,49		
						150		240,73		
Turn-off energy (per pulse)	$E_{off}$					25		44,92		
						125		55,92		
						150		60,45		
						25		1,11		mWs
						125		1,18		
						150		1,21		
						25		1,5		
						125		2,01		
						150		2,16		



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## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max

## Negative Boost Diode

## Static

Forward voltage	$V_F$				30	25 125 150		1,39 1,53 1,62	1,55 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_F = 650$ V			25 150		6 90	600	$\mu$ A	

## Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,48		K/W
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## Dynamic

Peak recovery current	$I_{RRM}$	$di/dt=2561$ A/ $\mu$ s $di/dt=2654$ A/ $\mu$ s $di/dt=2217$ A/ $\mu$ s	0/15	400	65	25 125 150		10,24 9,48 9,23		A
Reverse recovery time	$t_{rr}$					25 125 150		8,9 9,06 8,97		ns
Recovered charge	$Q_r$					25 125 150		0,053 0,052 0,05		$\mu$ C
Reverse recovered energy	$E_{rec}$					25 125 150		$8,891 \times 10^{-3}$ $8,195 \times 10^{-3}$ $7,967 \times 10^{-3}$		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		3321,92 2781,09 2867,81		$A/\mu$ s



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## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max

## Positive Boost Diode

## Static

Forward voltage	$V_F$				30	25 125 150		1,39 1,53 1,62	1,55 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_F = 650$ V				25 150		6 90	600	μA

## Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,48		K/W
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## Dynamic

Peak recovery current	$I_{RRM}$	$di/dt=1890$ A/μs $di/dt=1493$ A/μs $di/dt=1275$ A/μs	0/15	400	65	25		5,54		A
Reverse recovery time	$t_{rr}$					125		5,34		
Recovered charge	$Q_r$					150		5,54		
Recovered charge	$Q_r$		25			25		26,26		
Reverse recovered energy	$E_{rec}$		125			125		26,67		ns
Reverse recovered energy	$E_{rec}$		150			150		27,05		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		0/15	25		0,086		μC		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		400	125		0,082				
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		65	150		0,082				
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		25			25		0,021		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		125			125		0,019		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		150			150		0,019		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		25			25		638,68		A/μs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		125			125		636,5		
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$		150			150		666,84		



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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$I_C$ [A]	$T_j$ [°C]	Min	Typ	Max	

### Negative Neutral Point Diode

#### Static

Forward voltage	$V_F$				60	25 125 150		1,06 0,99 0,97	1,5 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_r = 1600$ V				25 150			100 2	µA

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,77		K/W
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### Positive Neutral Point Diode

#### Static

Forward voltage	$V_F$				110	25 125 150		1,11 1,03 1,03	1,5 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_r = 1600$ V				25 150			100 2000	µA

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,57		K/W
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## Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$I_D$ [A]	$T_j$ [°C]	Min	Typ	Max

### Positive Boost Diode Protection Diode

#### Static

Forward voltage	$V_F$				20	25 125 150	1,23	1,74 1,65 1,61	1,87 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_r = 650$ V			25			0,24	$\mu$ A	

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						2,46		K/W
--	---------------	---------------------------------------	--	--	--	--	--	------	--	-----

### Positive Boost Blocking Diode

#### Static

Forward voltage	$V_F$				60	25 125 150		1,06 0,99 0,97	1,5 <sup>(1)</sup>	V
Reverse leakage current	$I_R$	$V_r = 1600$ V			25 150			100 2	$\mu$ A	

#### Thermal

Thermal resistance junction to sink <sup>(2)</sup>	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,77		K/W
--	---------------	---------------------------------------	--	--	--	--	--	------	--	-----

### Capacitor (DC)

#### Static

Capacitance	$C$	DC bias voltage = 0 V				25		100		nF
Tolerance							-10		10	%



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## Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		$V_{GE}$ [V]	$V_{GS}$ [V]	$V_{CE}$ [V]	$V_{DS}$ [V]	$I_C$ [A]	$T_j$ [°C]	Min	Typ	Max

### Thermistor

#### Static

Rated resistance	$R$					25		22		kΩ
Deviation of $R_{100}$	$A_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	$P$					25		130		mW
Power dissipation constant	$d$					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %						4000		K
Vincotech Thermistor Reference									I	

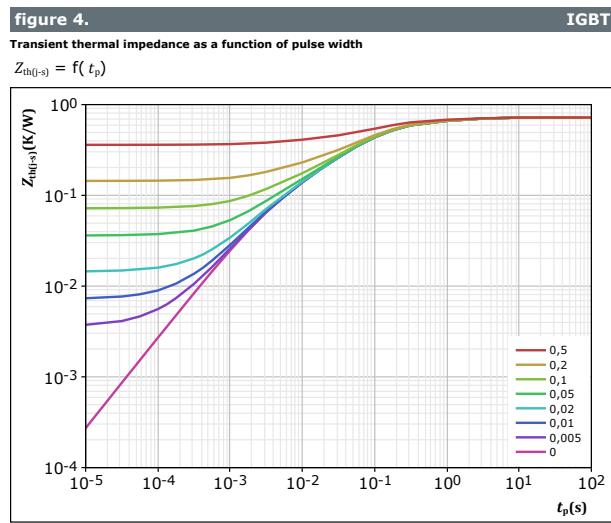
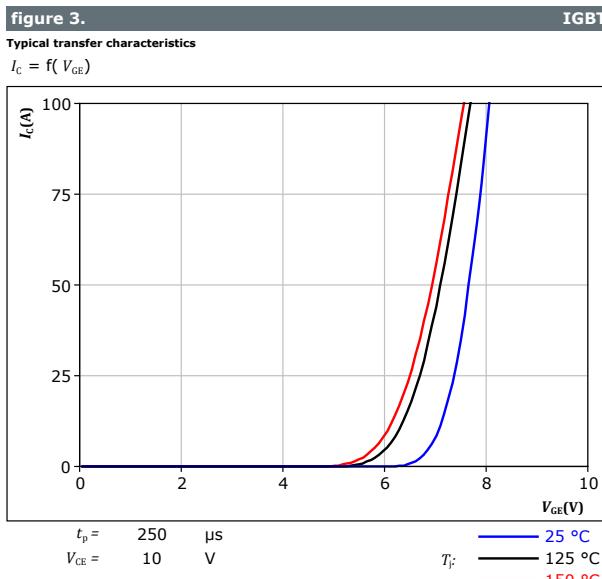
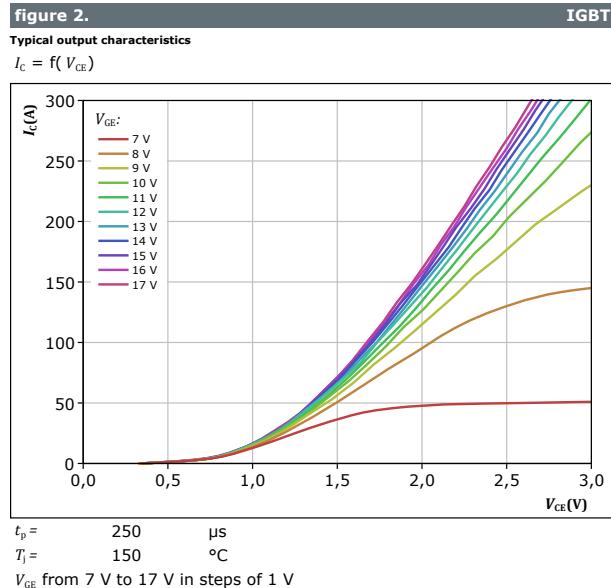
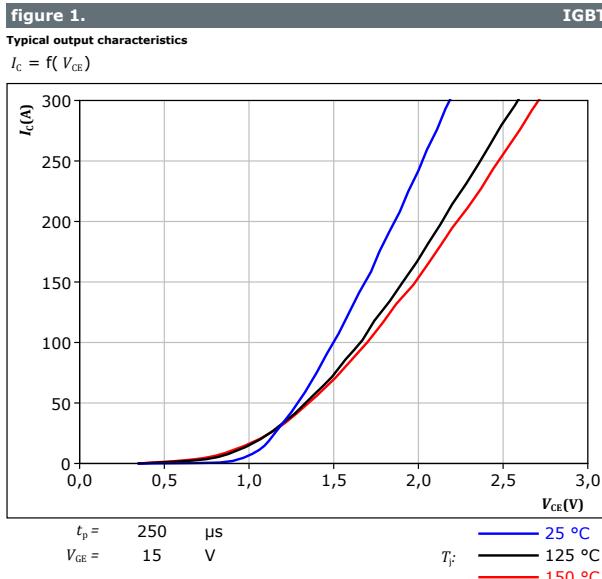
(<sup>1</sup>) Value at chip level

(<sup>2</sup>) Only valid with pre-applied Vincotech thermal interface material.



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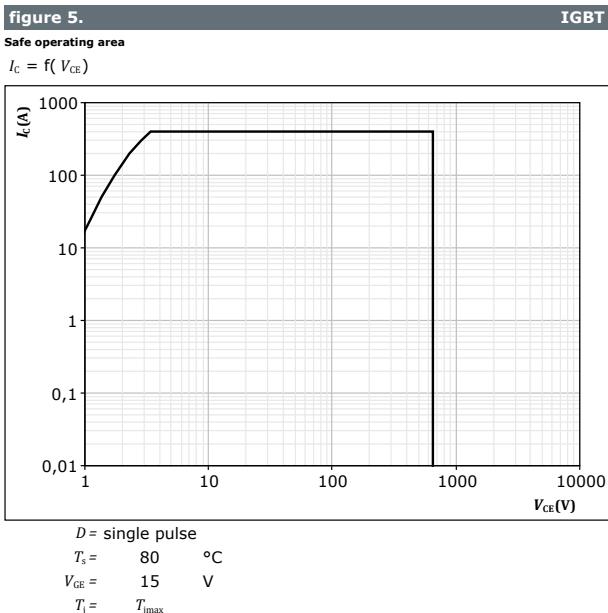
## Negative Neutral Point Switch Characteristics



$R$ (K/W)	$\tau$ (s)
6,28E-02	2,57E+00
9,58E-02	5,54E-01
3,57E-01	1,08E-01
1,45E-01	2,46E-02
6,02E-02	3,37E-03



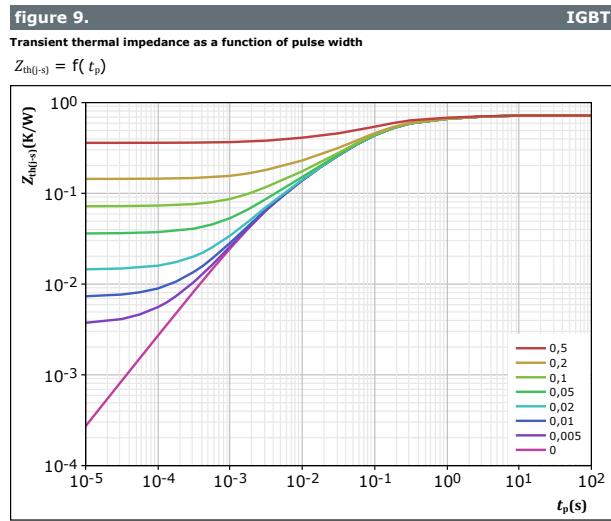
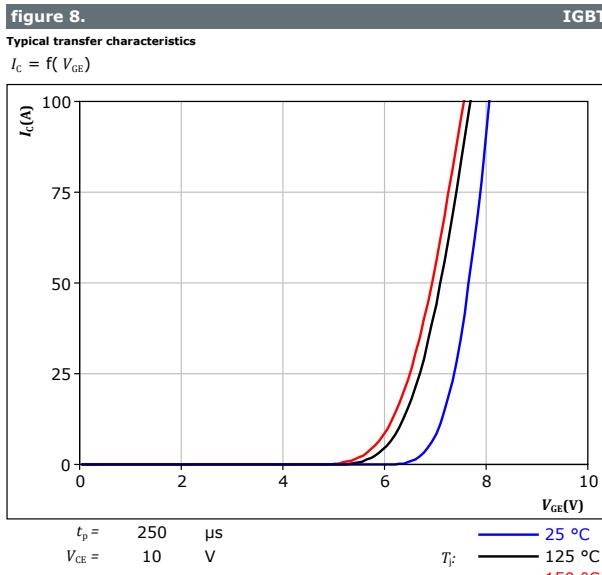
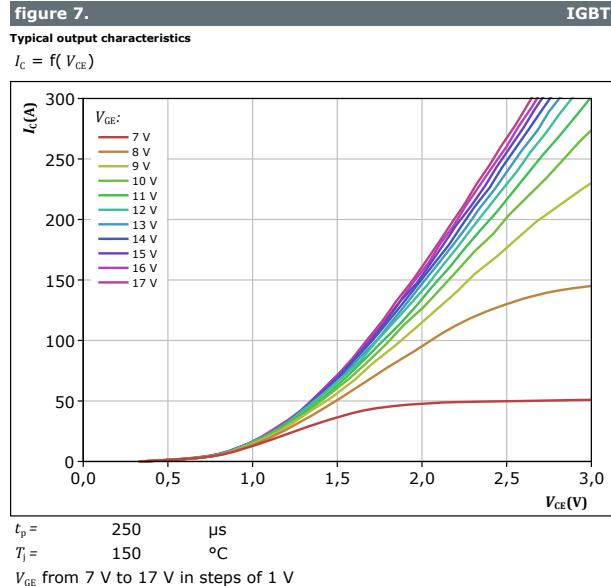
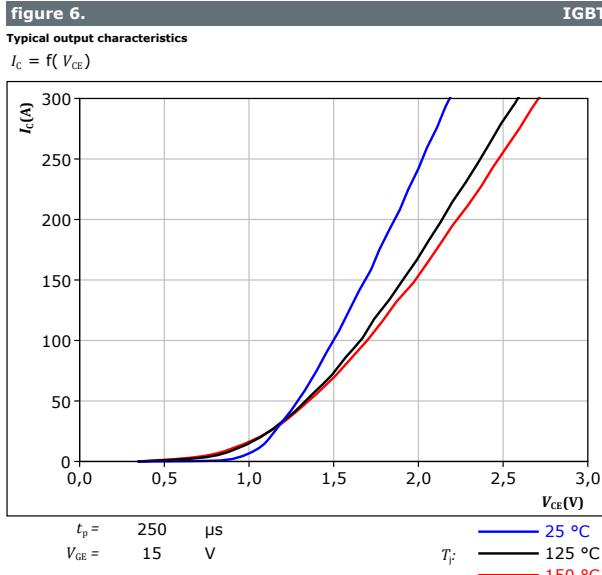
## Negative Neutral Point Switch Characteristics





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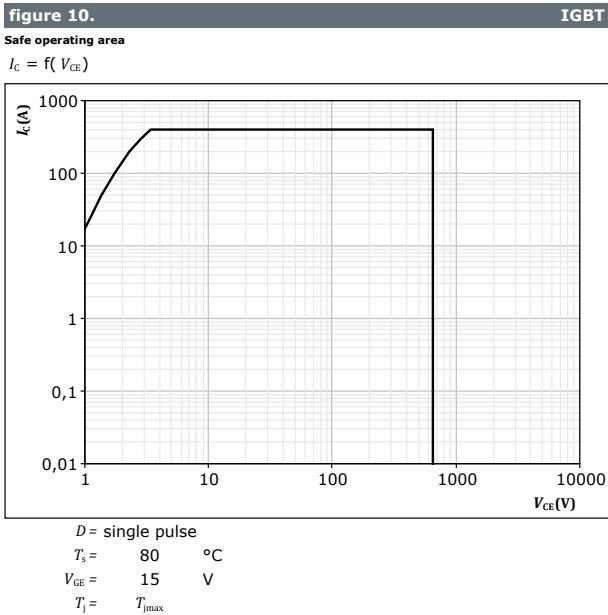
## Positive Neutral Point Switch Characteristics



IGBT thermal model values	
$R$ (K/W)	$\tau$ (s)
6,28E-02	2,57E+00
9,58E-02	5,54E-01
3,57E-01	1,08E-01
1,45E-01	2,46E-02
6,02E-02	3,37E-03



## Positive Neutral Point Switch Characteristics





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## Negative Boost Diode Characteristics

figure 11.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD

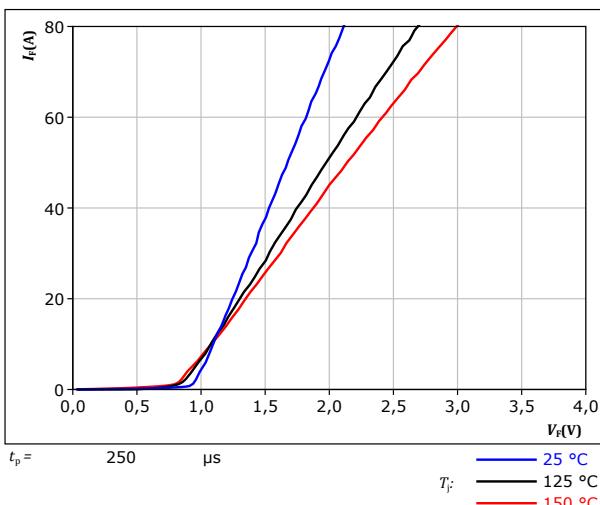
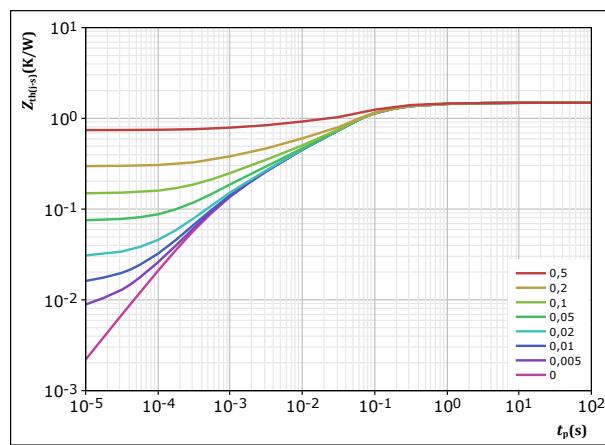


figure 12.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p}{T} \quad R_{th(j-s)} = \frac{t_p}{1,485} \text{ K/W}$$

FWD thermal model values

$R$ (K/W)	$\tau$ (s)
6,45E-02	1,95E+00
2,63E-01	2,25E-01
8,47E-01	5,10E-02
2,23E-01	4,17E-03
8,76E-02	5,85E-04



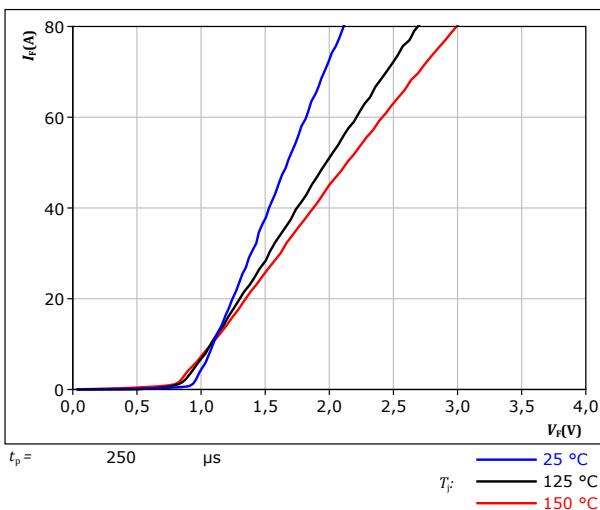
## Positive Boost Diode Characteristics

figure 13.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu s$$

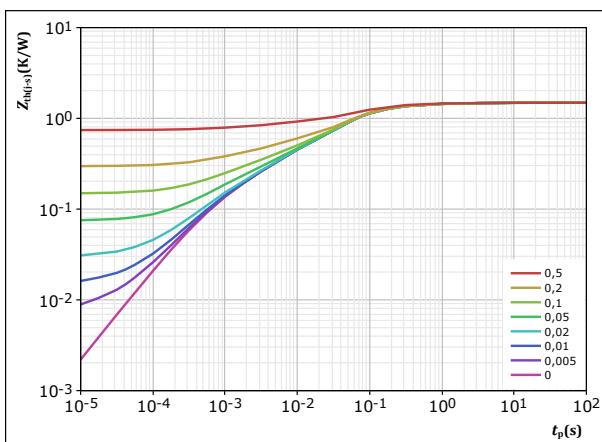
$T_F$ :  
— 25 °C  
— 125 °C  
— 150 °C

figure 14.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p / T}{R_{th(j-s)}} = 1,485 \text{ K/W}$$

FWD thermal model values

$R(K/W)$	$\tau(s)$
6,45E-02	1,95E+00
2,63E-01	2,25E-01
8,47E-01	5,10E-02
2,23E-01	4,17E-03
8,76E-02	5,85E-04



## Negative Neutral Point Diode Characteristics

figure 15.

Typical forward characteristics

$$I_F = f(V_F)$$

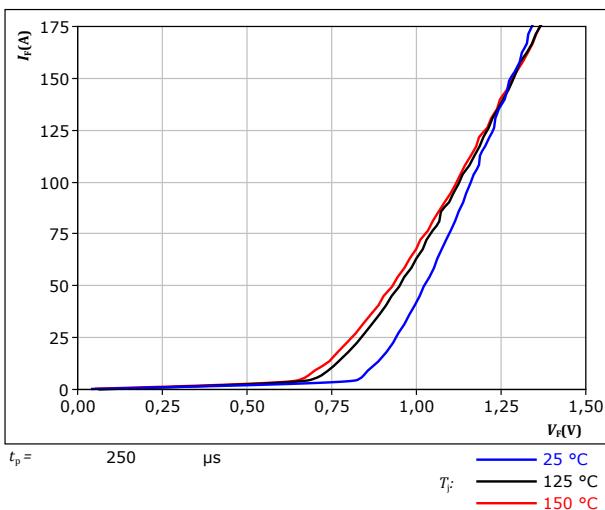
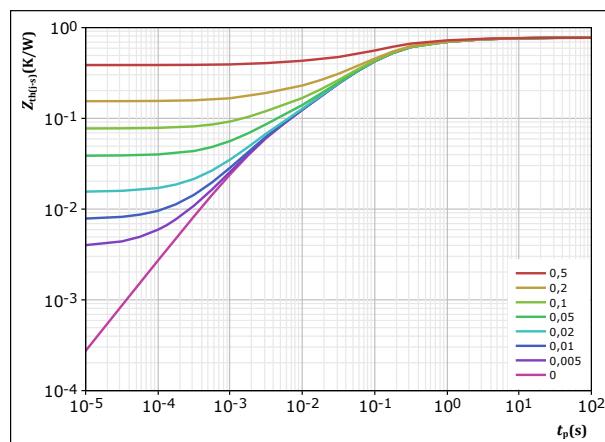


figure 16.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$$D = \frac{t_p}{T} = 0,772$$

$$R_{th(j-s)} = 0,772 \text{ K/W}$$

Rectifier thermal model values

$R$ (K/W)	$\tau$ (s)
2,82E-02	8,69E+00
1,16E-01	1,22E+00
4,16E-01	1,44E-01
1,62E-01	2,97E-02
5,02E-02	2,64E-03



## Positive Neutral Point Diode Characteristics

figure 17.

Typical forward characteristics

$$I_F = f(V_F)$$

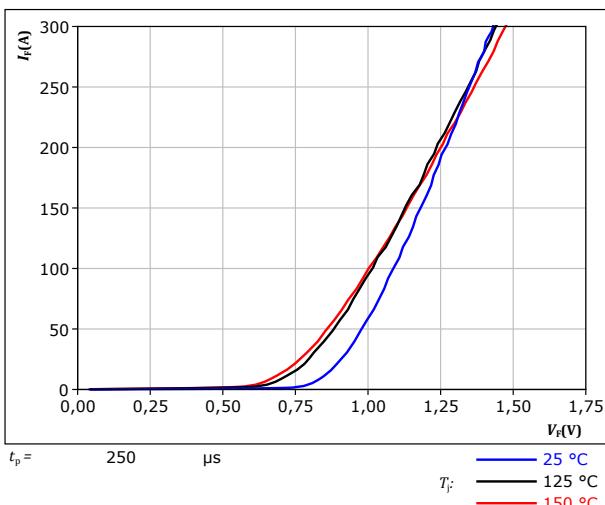
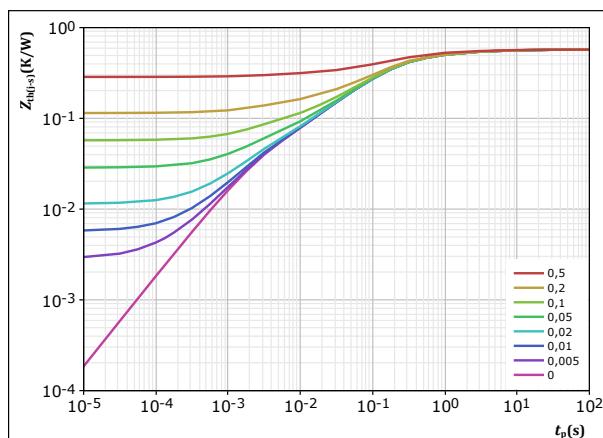


figure 18.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$





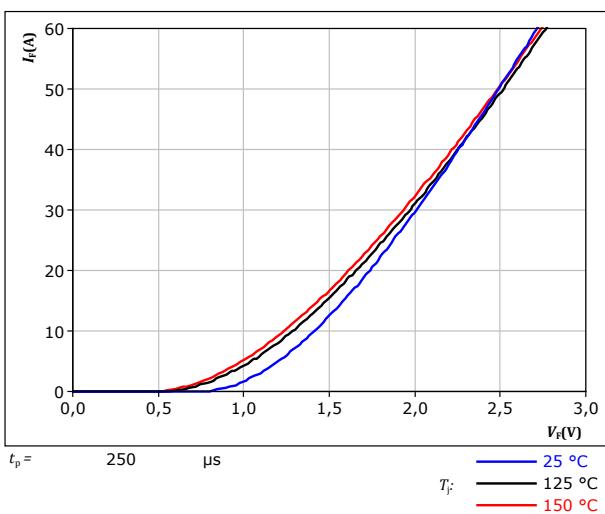
## Positive Boost Diode Protection Diode Characteristics

figure 19.

Typical forward characteristics

$$I_F = f(V_F)$$

FWD



$$t_p = 250 \mu\text{s}$$

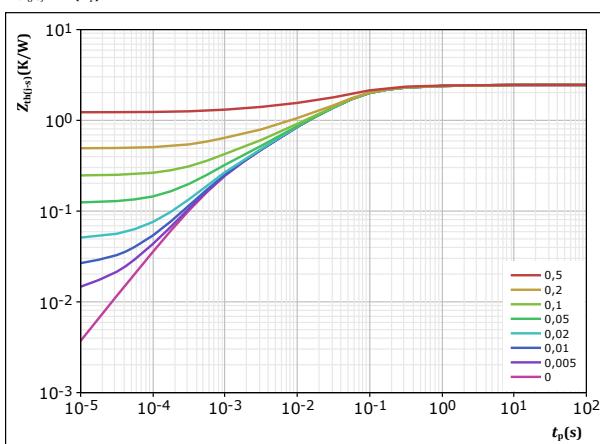
$T_F$ :   
— 25 °C  
— 125 °C  
— 150 °C

figure 20.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

FWD



$$D = \frac{t_p}{T} = 2,457 \text{ s}$$

FWD thermal model values

$R$ (K/W)	$\tau$ (s)
1,00E-01	2,27E+00
3,37E-01	2,00E-01
1,37E+00	4,58E-02
4,51E-01	6,21E-03
2,01E-01	7,45E-04



## Positive Boost Blocking Diode Characteristics

figure 21.

Typical forward characteristics

$$I_F = f(V_F)$$

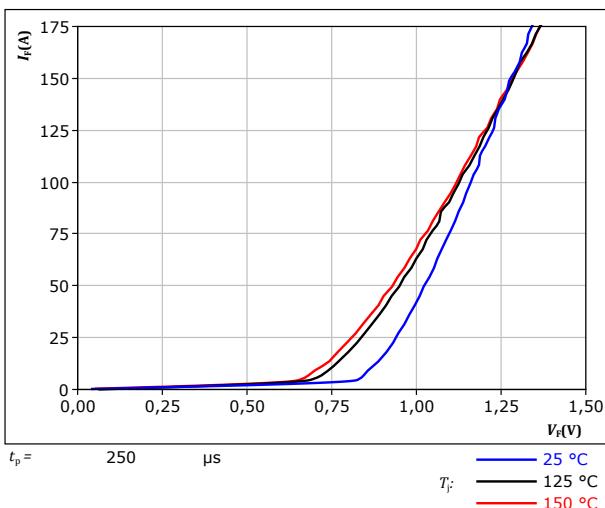
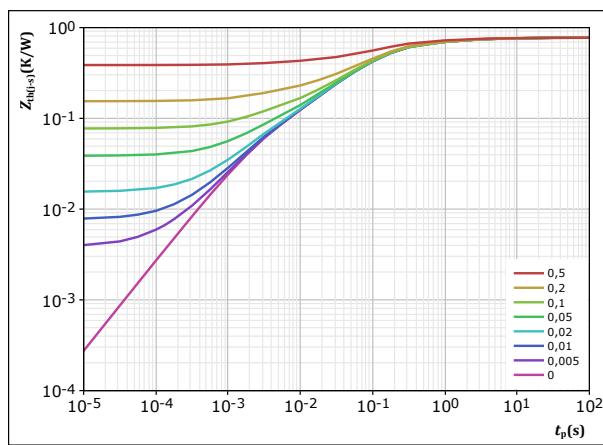


figure 22.

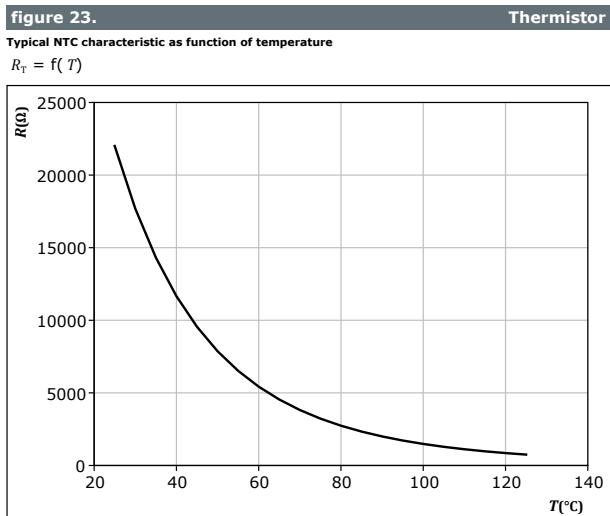
Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$





## Thermistor Characteristics





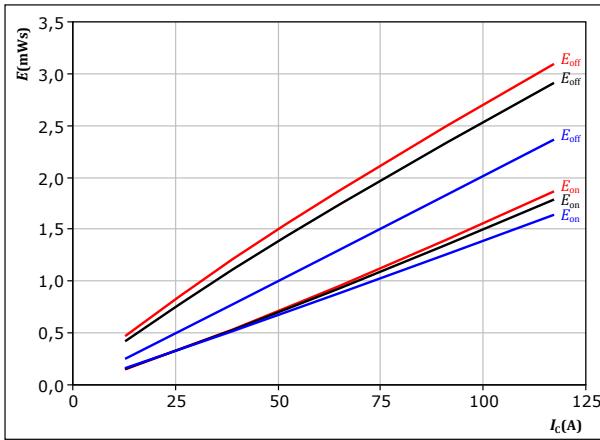
Vincotech

## Negative Neutral Point Switching Characteristics

figure 24.

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

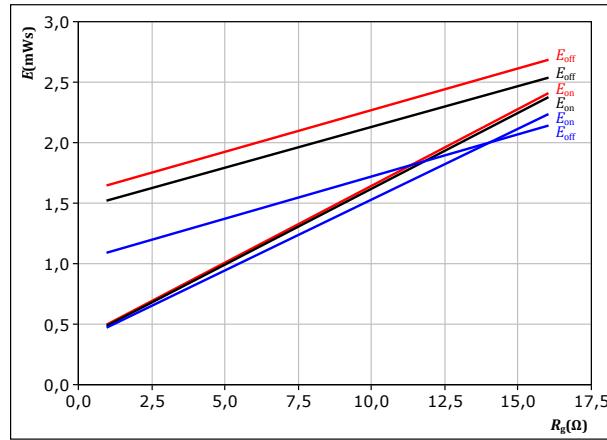
$$\begin{aligned} V_{CE} &= 400 \text{ V} \\ V_{GE} &= 0/15 \text{ V} \\ R_{gon} &= 4 \Omega \\ R_{goff} &= 4 \Omega \end{aligned}$$

IGBT

figure 25.

Typical switching energy losses as a function of IGBT turn on gate resistor

$$E = f(R_g)$$



With an inductive load at

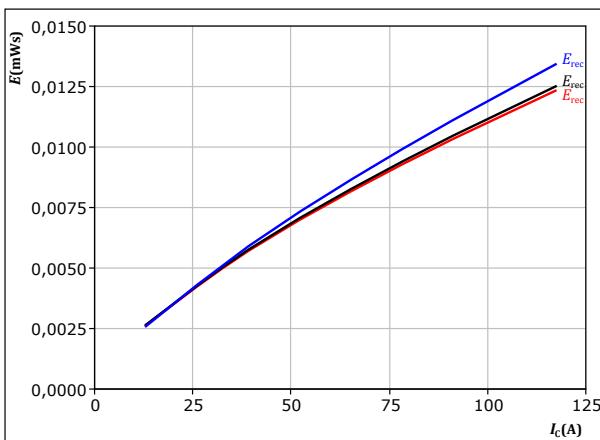
$$\begin{aligned} V_{CE} &= 400 \text{ V} \\ V_{GE} &= 0/15 \text{ V} \\ I_c &= 65 \text{ A} \end{aligned}$$

IGBT

figure 26.

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



With an inductive load at

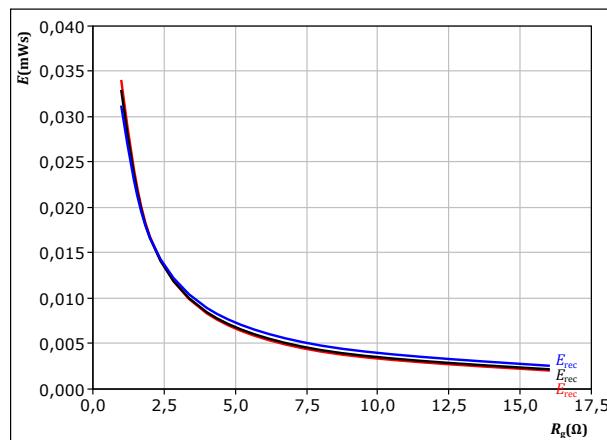
$$\begin{aligned} V_{CE} &= 400 \text{ V} \\ V_{GE} &= 0/15 \text{ V} \\ R_{gon} &= 4 \Omega \end{aligned}$$

FWD

figure 27.

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 400 \text{ V} \\ V_{GE} &= 0/15 \text{ V} \\ I_c &= 65 \text{ A} \end{aligned}$$

FWD



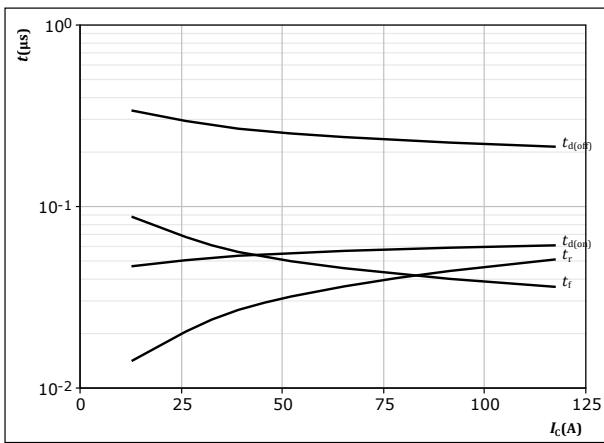
Vincotech

## Negative Neutral Point Switching Characteristics

figure 28.

IGBT

Typical switching times as a function of collector current  
 $t = f(I_C)$



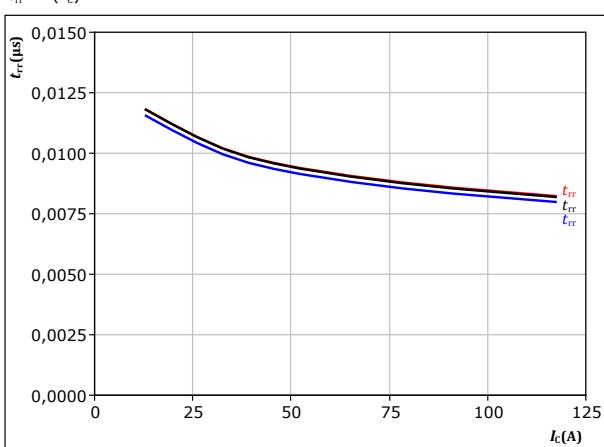
With an inductive load at

T<sub>j</sub> = 150 °C  
V<sub>CE</sub> = 400 V  
V<sub>GE</sub> = 0/15 V  
R<sub>gon</sub> = 4 Ω  
R<sub>goff</sub> = 4 Ω

figure 30.

FWD

Typical reverse recovery time as a function of collector current  
 $t_{rr} = f(I_C)$



With an inductive load at

V<sub>CE</sub> = 400 V  
V<sub>GE</sub> = 0/15 V  
R<sub>gon</sub> = 4 Ω

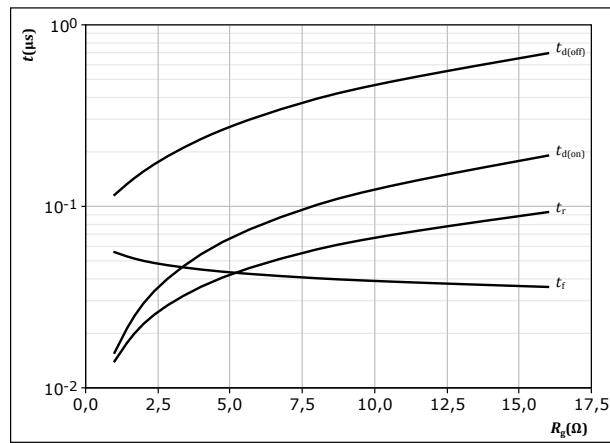
T<sub>j</sub>:

— 25 °C  
— 125 °C  
— 150 °C

figure 29.

IGBT

Typical switching times as a function of IGBT turn on gate resistor  
 $t = f(R_g)$



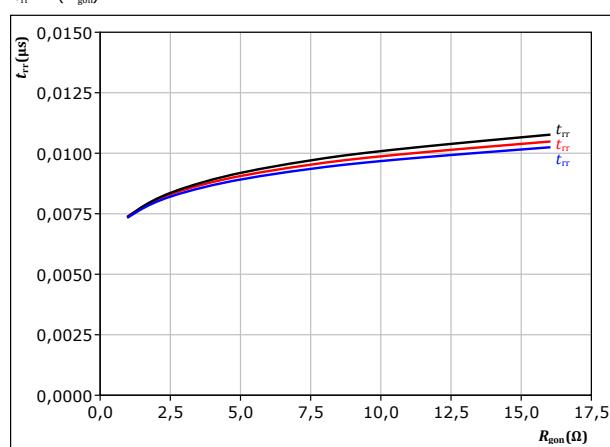
With an inductive load at

T<sub>j</sub> = 150 °C  
V<sub>CE</sub> = 400 V  
V<sub>GE</sub> = 0/15 V  
I<sub>C</sub> = 65 A

figure 31.

FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor  
 $t_{rr} = f(R_{gon})$



With an inductive load at

V<sub>CE</sub> = 400 V  
V<sub>GE</sub> = 0/15 V  
I<sub>C</sub> = 65 A

T<sub>j</sub>:

— 25 °C  
— 125 °C  
— 150 °C



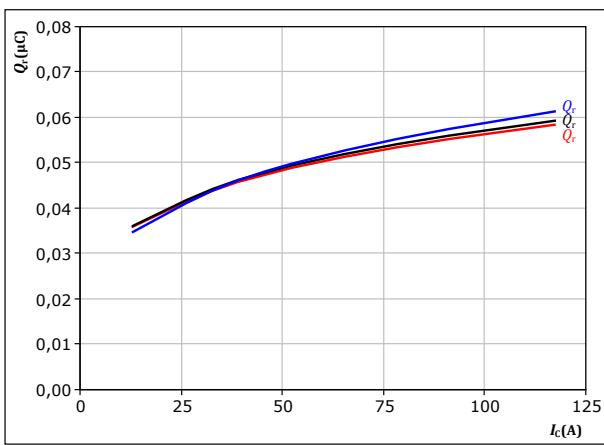
Vincotech

## Negative Neutral Point Switching Characteristics

figure 32.

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

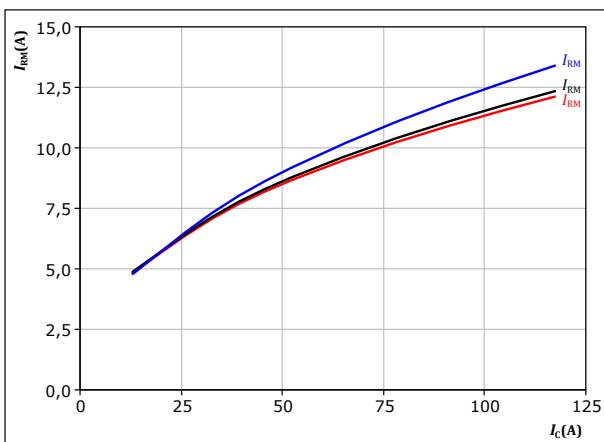
$V_{CE} =$	400	V
$V_{GE} =$	0/15	V
$R_{gon} =$	4	Ω

$T_f:$  — 25 °C    — 125 °C    — 150 °C

figure 34.

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

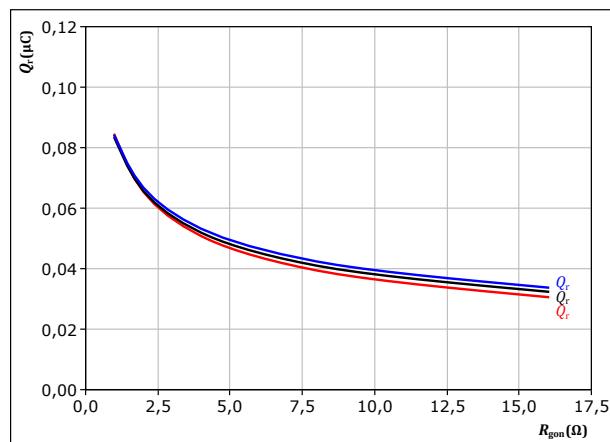
$V_{CE} =$	400	V
$V_{GE} =$	0/15	V
$R_{gon} =$	4	Ω

$T_f:$  — 25 °C    — 125 °C    — 150 °C

figure 33.

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

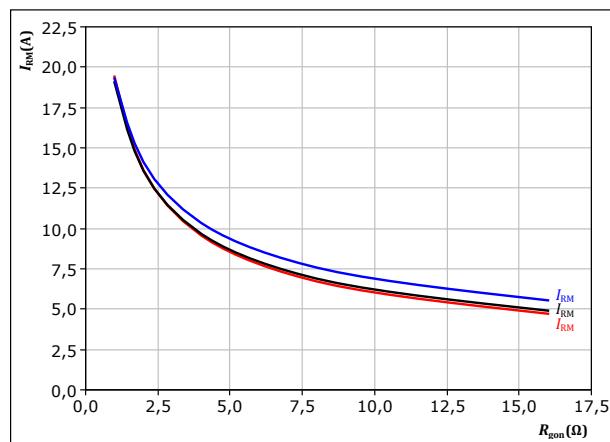
$V_{CE} =$	400	V
$V_{GE} =$	0/15	V
$I_c =$	65	A

$T_f:$  — 25 °C    — 125 °C    — 150 °C

figure 35.

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$V_{CE} =$	400	V
$V_{GE} =$	0/15	V
$I_c =$	65	A

$T_f:$  — 25 °C    — 125 °C    — 150 °C

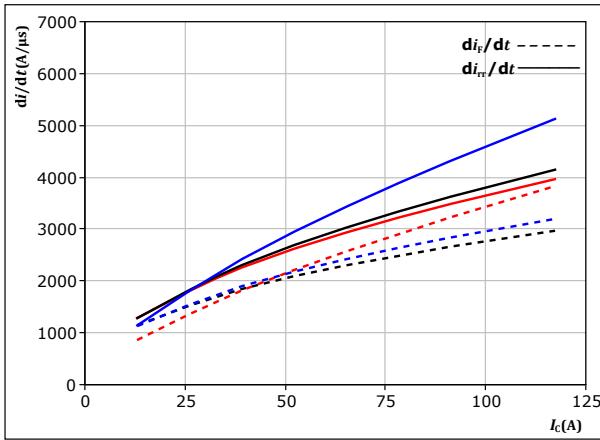


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## Negative Neutral Point Switching Characteristics

figure 36. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_f/dt, di_{rr}/dt = f(I_c)$

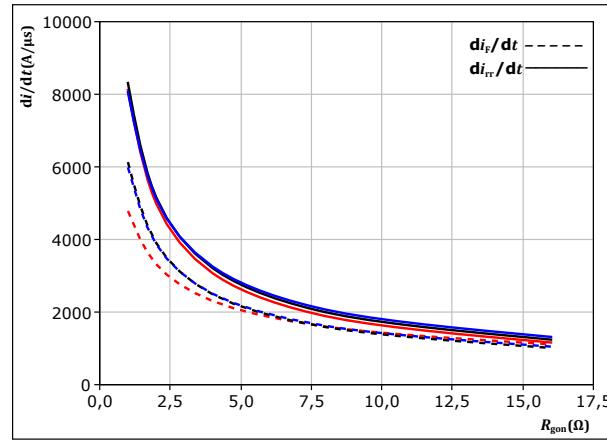


With an inductive load at

$V_{CE} = 400 \text{ V}$        $T_j: 25^\circ\text{C}$   
 $V_{GE} = 0/15 \text{ V}$        $125^\circ\text{C}$   
 $R_{gon} = 4 \Omega$        $150^\circ\text{C}$

figure 37. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor  
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



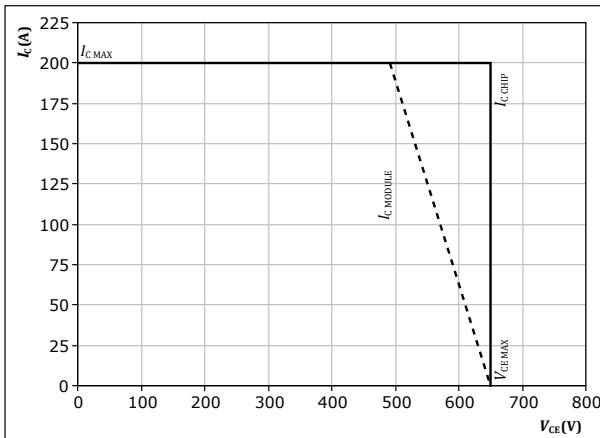
With an inductive load at

$V_{CE} = 400 \text{ V}$        $T_j: 25^\circ\text{C}$   
 $V_{GE} = 0/15 \text{ V}$        $125^\circ\text{C}$   
 $I_c = 65 \text{ A}$        $150^\circ\text{C}$

figure 38. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At       $T_j = 150^\circ\text{C}$   
 $R_{gon} = 4 \Omega$   
 $R_{goff} = 4 \Omega$

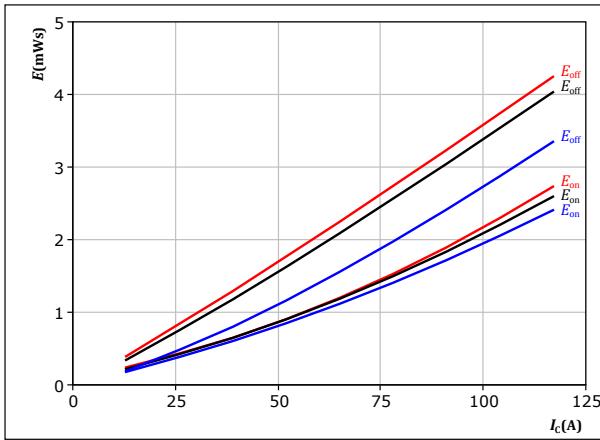


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## Positive Neutral Point Switching Characteristics

figure 39. IGBT

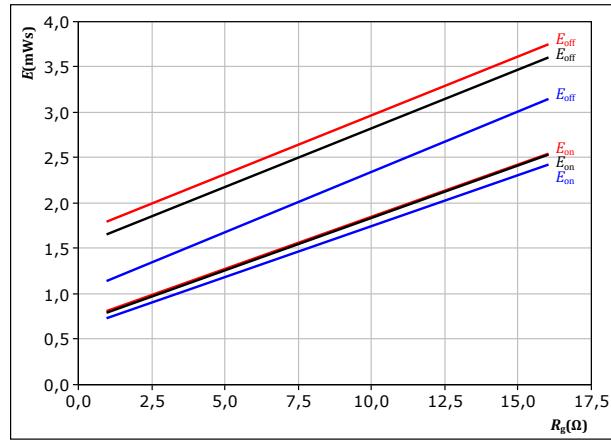
Typical switching energy losses as a function of collector current  
 $E = f(I_c)$



With an inductive load at  
 $V_{CE} = 400$  V       $T_j:$  25 °C  
 $V_{GE} = 0/15$  V      125 °C  
 $R_{gon} = 4$  Ω      150 °C  
 $R_{goff} = 4$  Ω

figure 40. IGBT

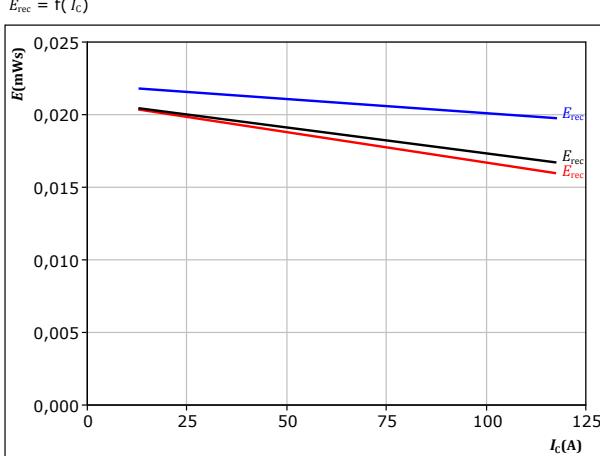
Typical switching energy losses as a function of IGBT turn on gate resistor  
 $E = f(R_g)$



With an inductive load at  
 $V_{CE} = 400$  V       $T_j:$  25 °C  
 $V_{GE} = 0/15$  V      125 °C  
 $I_c = 65$  A      150 °C

figure 41. FWD

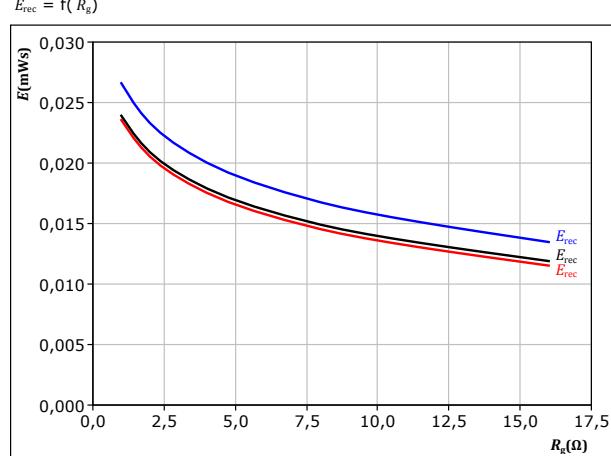
Typical reverse recovered energy loss as a function of collector current  
 $E_{rec} = f(I_c)$



With an inductive load at  
 $V_{CE} = 400$  V       $T_j:$  25 °C  
 $V_{GE} = 0/15$  V      125 °C  
 $R_{gon} = 4$  Ω

figure 42. FWD

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor  
 $E_{rec} = f(R_g)$



With an inductive load at  
 $V_{CE} = 400$  V       $T_j:$  25 °C  
 $V_{GE} = 0/15$  V      125 °C  
 $I_c = 65$  A      150 °C

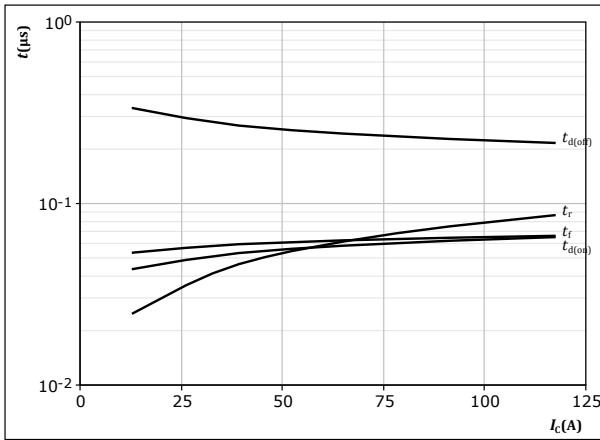


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## Positive Neutral Point Switching Characteristics

figure 43. IGBT

Typical switching times as a function of collector current  
 $t = f(I_C)$

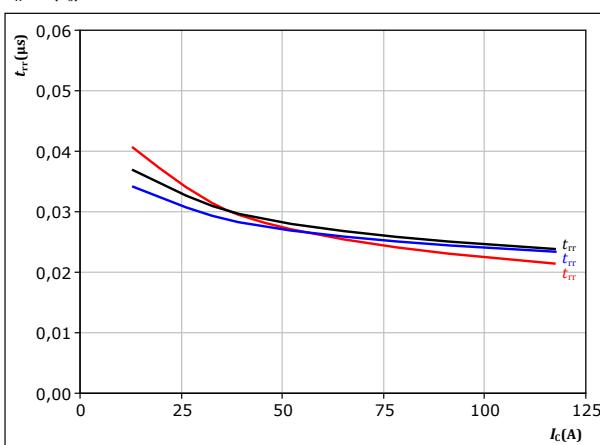


With an inductive load at

$T_j = 150^\circ\text{C}$   
 $V_{CE} = 400 \text{ V}$   
 $V_{GE} = 0/15 \text{ V}$   
 $R_{gon} = 4 \Omega$   
 $R_{goff} = 4 \Omega$

figure 45. FWD

Typical reverse recovery time as a function of collector current  
 $t_{rr} = f(I_C)$

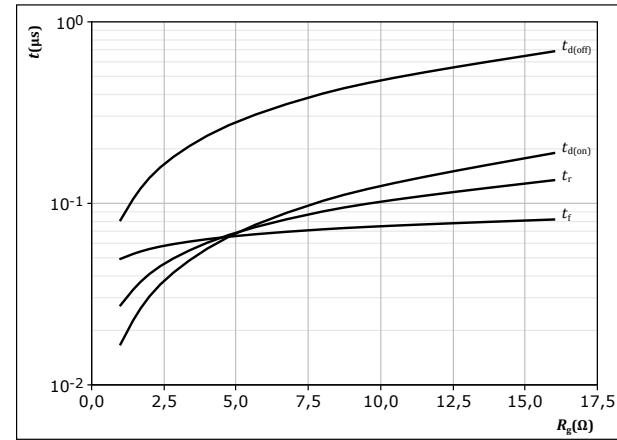


With an inductive load at

$V_{CE} = 400 \text{ V}$   
 $V_{GE} = 0/15 \text{ V}$   
 $R_{gon} = 4 \Omega$

figure 44. IGBT

Typical switching times as a function of IGBT turn on gate resistor  
 $t = f(R_g)$

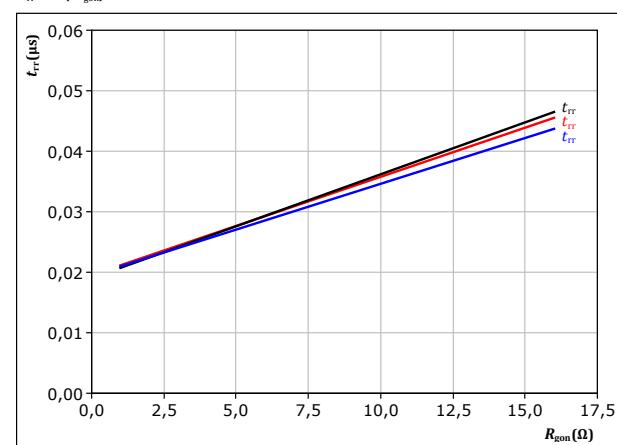


With an inductive load at

$T_j = 150^\circ\text{C}$   
 $V_{CE} = 400 \text{ V}$   
 $V_{GE} = 0/15 \text{ V}$   
 $I_C = 65 \text{ A}$

figure 46. FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor  
 $t_{rr} = f(R_{gon})$



With an inductive load at

$V_{CE} = 400 \text{ V}$   
 $V_{GE} = 0/15 \text{ V}$   
 $I_C = 65 \text{ A}$



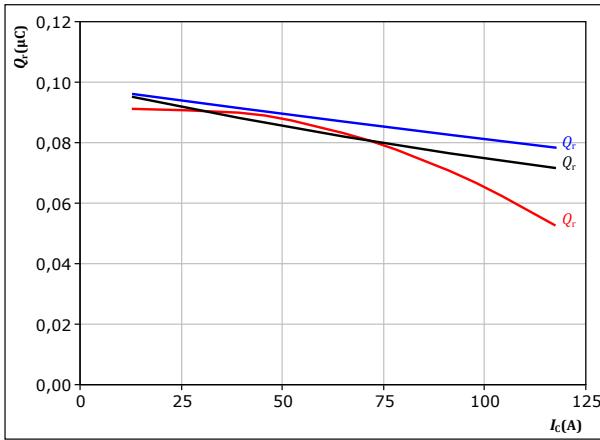
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## Positive Neutral Point Switching Characteristics

figure 47.

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

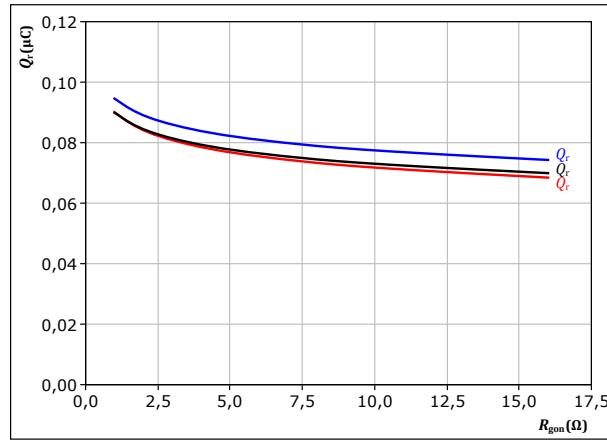
$$\begin{aligned} V_{CE} &= 400 \text{ V} \\ V_{GE} &= 0/15 \text{ V} \\ R_{gon} &= 4 \Omega \end{aligned}$$

FWD

figure 48.

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

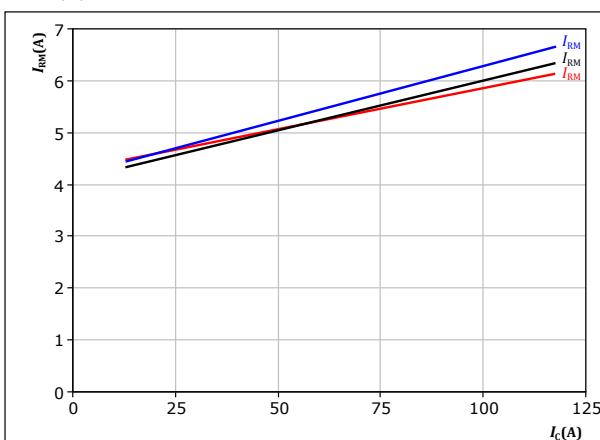
$$\begin{aligned} V_{CE} &= 400 \text{ V} \\ V_{GE} &= 0/15 \text{ V} \\ I_c &= 65 \text{ A} \end{aligned}$$

FWD

figure 49.

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

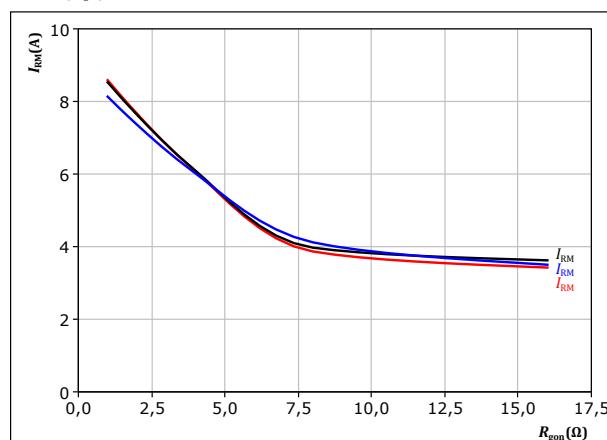
$$\begin{aligned} V_{CE} &= 400 \text{ V} \\ V_{GE} &= 0/15 \text{ V} \\ R_{gon} &= 4 \Omega \end{aligned}$$

FWD

figure 50.

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 400 \text{ V} \\ V_{GE} &= 0/15 \text{ V} \\ I_c &= 65 \text{ A} \end{aligned}$$

FWD

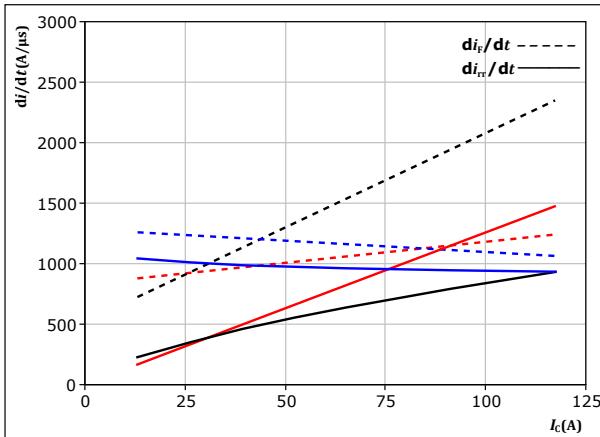


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## Positive Neutral Point Switching Characteristics

figure 51. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current  
 $di_f/dt, di_{rr}/dt = f(I_c)$

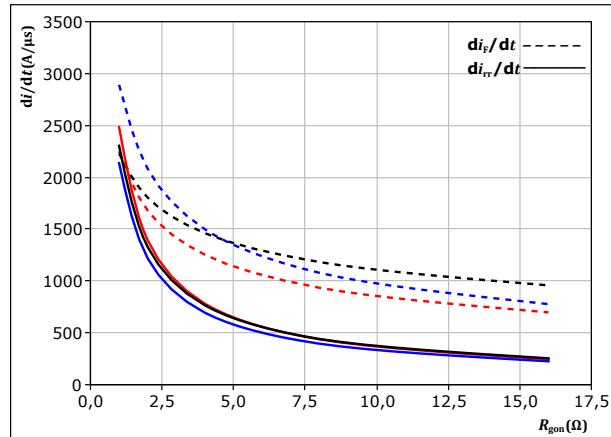


With an inductive load at

$V_{CE} = 400 \text{ V}$        $T_j = 25^\circ\text{C}$   
 $V_{GE} = 0/15 \text{ V}$        $T_j = 125^\circ\text{C}$   
 $R_{gon} = 4 \Omega$        $T_j = 150^\circ\text{C}$

figure 52. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor  
 $di_f/dt, di_{rr}/dt = f(R_{gon})$



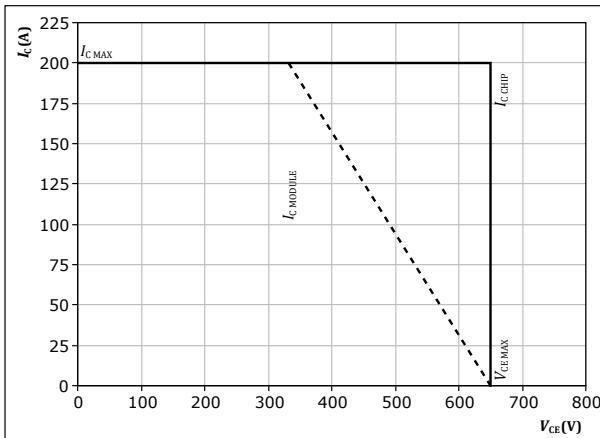
With an inductive load at

$V_{CE} = 400 \text{ V}$        $T_j = 25^\circ\text{C}$   
 $V_{GE} = 0/15 \text{ V}$        $T_j = 125^\circ\text{C}$   
 $I_c = 65 \text{ A}$        $T_j = 150^\circ\text{C}$

figure 53. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At       $T_j = 150^\circ\text{C}$   
 $R_{gon} = 4 \Omega$   
 $R_{goff} = 4 \Omega$



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## Switching Definitions

figure 54. IGBT

Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$  ( $t_{Eoff}$  = integrating time for  $E_{off}$ )

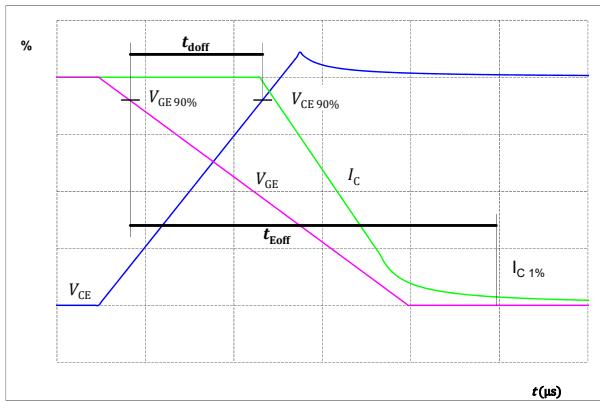


figure 56. IGBT

Turn-off Switching Waveforms & definition of  $t_f$

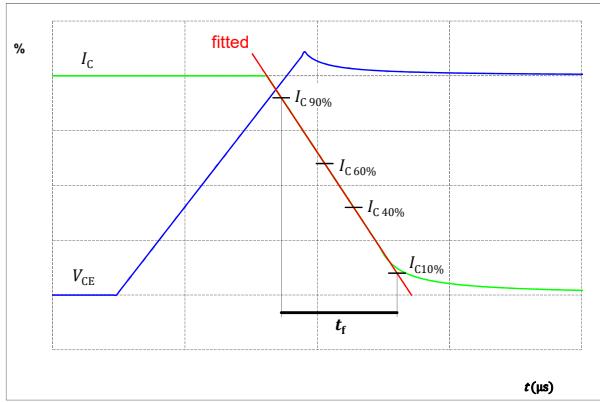


figure 55. IGBT

Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$  ( $t_{Eon}$  = integrating time for  $E_{on}$ )

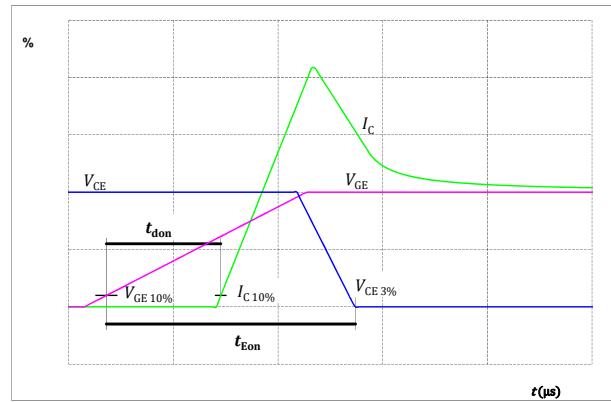
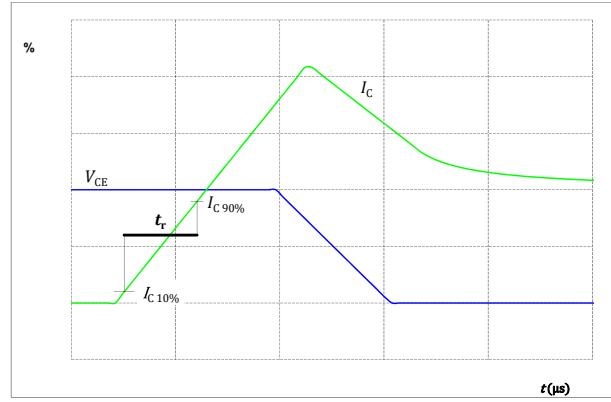


figure 57. IGBT

Turn-on Switching Waveforms & definition of  $t_r$





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## Switching Definitions

figure 58.

Turn-off Switching Waveforms & definition of  $t_{tr}$

FWD

Turn-off Switching Waveforms & definition of  $t_{tr}$

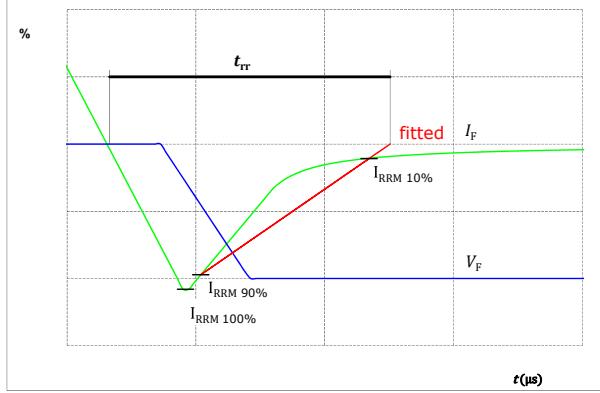
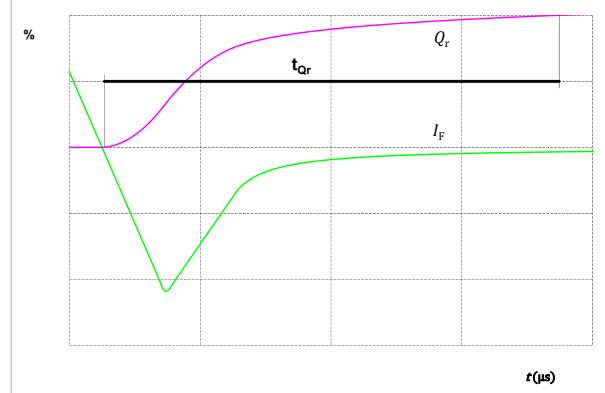


figure 59.

Turn-on Switching Waveforms & definition of  $t_{qr}$  ( $t_{qr}$  = integrating time for  $Q_r$ )

FWD

Turn-on Switching Waveforms & definition of  $t_{qr}$  ( $t_{qr}$  = integrating time for  $Q_r$ )





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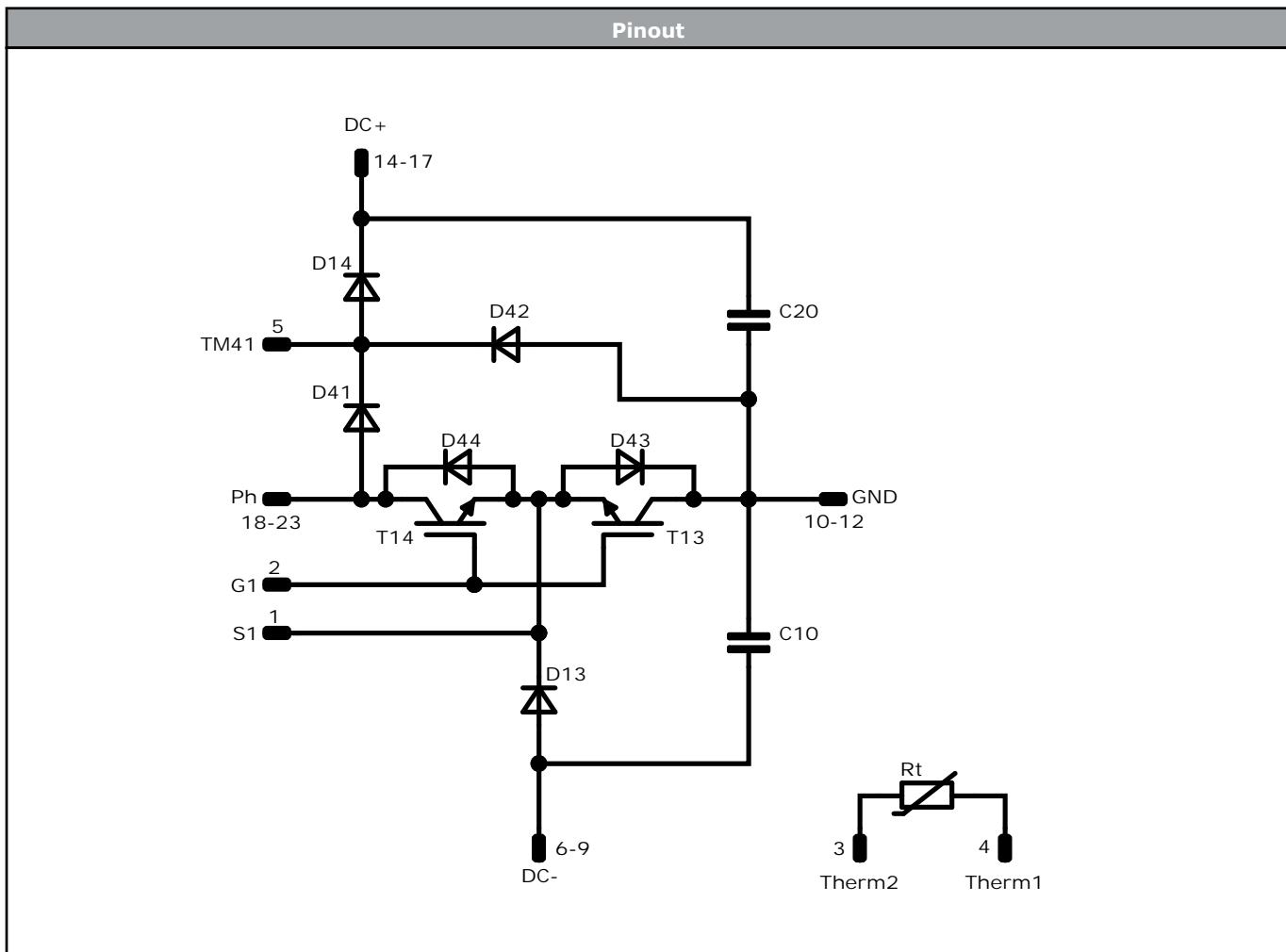
Ordering Code	
Version	Ordering Code
Without thermal paste	10-PY07ANA100RG01-LH23L68Y
With thermal paste (5,2 W/mK, PTM6000HV)	10-PY07ANA100RG01-LH23L68Y-/7/
With thermal paste (3,4 W/mK, PSX-P7)	10-PY07ANA100RG01-LH23L68Y-/3/

Marking						
Text	Name		Date code	UL & VIN	Lot	Serial
	NN-NNNNNNNNNNNNNNNNNN-	WWYY	UL VIN	LLLLL	SSSS	
Datamatrix	Type&Ver	Lot number	Serial	Date code		
	TTTTTTTVV	LLLLL	SSSS	WWYY		

Outline																																																																																																			
<table border="1"><caption>Pin table [mm]</caption><thead><tr><th>Pin</th><th>X</th><th>Y</th><th>Function</th></tr></thead><tbody><tr><td>1</td><td>24,4</td><td>6,6</td><td>S1</td></tr><tr><td>2</td><td>24,4</td><td>3,6</td><td>G1</td></tr><tr><td>3</td><td>3</td><td>0</td><td>Therm2</td></tr><tr><td>4</td><td>0</td><td>0</td><td>Therm1</td></tr><tr><td>5</td><td>26,5</td><td>17,75</td><td>TM41</td></tr><tr><td>6</td><td>8,6</td><td>26</td><td>DC-</td></tr><tr><td>7</td><td>8,6</td><td>29</td><td>DC-</td></tr><tr><td>8</td><td>11,6</td><td>26</td><td>DC-</td></tr><tr><td>9</td><td>11,6</td><td>29</td><td>DC-</td></tr><tr><td>10</td><td>20</td><td>26</td><td>GND</td></tr><tr><td>11</td><td>20</td><td>29</td><td>GND</td></tr><tr><td>12</td><td>23</td><td>26</td><td>GND</td></tr><tr><td>13</td><td>23</td><td>29</td><td>GND</td></tr><tr><td>14</td><td>31,4</td><td>26</td><td>DC+</td></tr><tr><td>15</td><td>31,4</td><td>29</td><td>DC+</td></tr><tr><td>16</td><td>34,4</td><td>26</td><td>DC+</td></tr><tr><td>17</td><td>34,4</td><td>29</td><td>DC+</td></tr><tr><td>18</td><td>47</td><td>12</td><td>Ph</td></tr><tr><td>19</td><td>47</td><td>15</td><td>Ph</td></tr><tr><td>20</td><td>50</td><td>12</td><td>Ph</td></tr><tr><td>21</td><td>50</td><td>15</td><td>Ph</td></tr><tr><td>22</td><td>53</td><td>12</td><td>Ph</td></tr><tr><td>23</td><td>53</td><td>15</td><td>Ph</td></tr></tbody></table>	Pin	X	Y	Function	1	24,4	6,6	S1	2	24,4	3,6	G1	3	3	0	Therm2	4	0	0	Therm1	5	26,5	17,75	TM41	6	8,6	26	DC-	7	8,6	29	DC-	8	11,6	26	DC-	9	11,6	29	DC-	10	20	26	GND	11	20	29	GND	12	23	26	GND	13	23	29	GND	14	31,4	26	DC+	15	31,4	29	DC+	16	34,4	26	DC+	17	34,4	29	DC+	18	47	12	Ph	19	47	15	Ph	20	50	12	Ph	21	50	15	Ph	22	53	12	Ph	23	53	15	Ph			
Pin	X	Y	Function																																																																																																
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2	24,4	3,6	G1																																																																																																
3	3	0	Therm2																																																																																																
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5	26,5	17,75	TM41																																																																																																
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7	8,6	29	DC-																																																																																																
8	11,6	26	DC-																																																																																																
9	11,6	29	DC-																																																																																																
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22	53	12	Ph																																																																																																
23	53	15	Ph																																																																																																
			Tolerance of pinpositions: +/-0.5mm at the end of pins Dimension of coordinate axis is only offset without tolerance																																																																																																



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### Identification

ID	Component	Voltage	Current	Function	Comment
T13	IGBT	650 V	100 A	Negative Neutral Point Switch	
T14	IGBT	650 V	100 A	Positive Neutral Point Switch	
D13	FWD	650 V	30 A	Negative Boost Diode	
D14	FWD	650 V	30 A	Positive Boost Diode	
D43	Rectifier	1600 V	60 A	Negative Neutral Point Diode	
D44	Rectifier	1600 V	110 A	Positive Neutral Point Diode	
D42	FWD	650 V	20 A	Positive Boost Diode Protection Diode	
D41	Rectifier	1600 V	60 A	Positive Boost Blocking Diode	
C10, C20	Capacitor	630 V		Capacitor (DC)	
Rt	Thermistor			Thermistor	

**10-PY07ANA100RG01-LH23L68Y**

datasheet

**Vincotech****Packaging instruction**

Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ	Sample
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**Handling instruction**

Handling instructions for flow 1 packages see vincotech.com website.

**Package data**

Package data for flow 1 packages see vincotech.com website.

**Vincotech thermistor reference**

See Vincotech thermistor reference table at vincotech.com website.

**UL recognition and file number**

This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
10-PY07ANA100RG01-LH23L68Y-D1-14	19 Apr. 2022		

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.